

## N-Channel Super Junction Power MOSFET IV

### General Description

The series of devices use advanced trench gate super junction technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge. This super junction MOSFET fits the industry's AC-DC SMPS requirements for PFC, AC/DC power conversion, and industrial power applications.

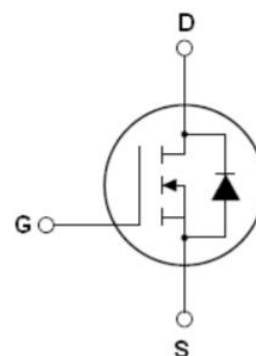
### Features

- Optimized body diode reverse recovery performance
- Low on-resistance and low conduction losses
- Small package
- Ultra Low Gate Charge cause lower driving requirements
- 100% Avalanche Tested
- ROHS compliant

### Application

- Power factor correction (PFC)
- Switched mode power supplies(SMPS)
- Uninterruptible Power Supply (UPS)
- LLC Half-bridge

$V_{DS\ min@T_{jmax}}$	710	V
$R_{DS(ON)TYP.}$	700	mΩ
$I_D$	5.8	A
$Q_g$	8.7	nC



Schematic diagram

### Package Marking And Ordering Information

Device	Device Package	Marking
NCE65N800R	SOT-223-2L	NCE65N800R



SOT-223-2L

Table 1. Absolute Maximum Ratings ( $T_c=25^{\circ}C$ )

Parameter	Symbol	Value	Unit
Drain-Source Voltage ( $V_{GS}=0V$ )	$V_{DS}$	650	V
Gate-Source Voltage ( $V_{DS}=0V$ ), AC ( $f>1\ Hz$ )	$V_{GS}$	$\pm 30$	V
Gate-Source Voltage ( $V_{DS}=0V$ ), DC	$V_{GS}$	$\pm 20$	V
Continuous Drain Current at $T_c=25^{\circ}C$	$I_{D(DC)}$	5.8	A
Continuous Drain Current at $T_c=100^{\circ}C$	$I_{D(DC)}$	4.06	A
Pulsed drain current (Note 1)	$I_{DM(pluse)}$	17.4	A
Maximum Power Dissipation( $T_c=25^{\circ}C$ )	$P_D$	5.1	W
Derate above $25^{\circ}C$		0.034	W/ $^{\circ}C$
Single pulse avalanche current (Note 2)	$I_{AS}$	1.5	A
Reverse diode dv/dt, $V_{DS} \leq 480\ V, I_{SD} < I_D$	dv/dt	15	V/ns
Drain Source voltage slope, $V_{DS} \leq 480\ V$	dv/dt	50	V/ns
Operating Junction and Storage Temperature Range	$T_J, T_{STG}$	-55...+175	$^{\circ}C$

**Table 2. Thermal Characteristic**

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case (Maximum)	$R_{thJC}$	29.41	$^{\circ}C/W$
Thermal Resistance, Junction-to-Ambient (Maximum)	$R_{thJA}$	62	$^{\circ}C/W$

**Table 3. Electrical Characteristics (TA=25°C unless otherwise noted)**

Parameter	Symbol	Condition	Min	Typ	Max	Unit
On/off states						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250uA	650			V
Zero Gate Voltage Drain Current(Tc=25℃)	I <sub>DSS</sub>	V <sub>DS</sub> =650V,V <sub>GS</sub> =0V			1	μA
Zero Gate Voltage Drain Current(Tc=125℃)	I <sub>DSS</sub>	V <sub>DS</sub> =650V,V <sub>GS</sub> =0V			50	μA
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V,V <sub>DS</sub> =0V			±200	nA
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> ,I <sub>D</sub> =250uA	3		4	V
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =2.9A		700	800	mΩ
Dynamic Characteristics						
Gate Resistance	R <sub>g</sub>	F=1MHZ, D-S short		47		Ω
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> =50V,V <sub>GS</sub> =0V, F=1MHz		314		pF
Output Capacitance	C <sub>OSS</sub>			18		pF
Reverse Transfer Capacitance	C <sub>rSS</sub>			3.5		pF
Total Gate Charge	Q <sub>g</sub>	V <sub>DS</sub> =480V,I <sub>D</sub> =3A, V <sub>GS</sub> =10V		8.7		nC
Gate-Source Charge	Q <sub>gs</sub>			1.7		nC
Gate-Drain Charge	Q <sub>gd</sub>			3.0		nC
Gate plateau voltage	V <sub>gp</sub>			5.1		V
Switching times						
Turn-on Delay Time	t <sub>d(on)</sub>	V <sub>DD</sub> =480V,I <sub>D</sub> =3A, R <sub>G</sub> =4Ω,V <sub>GS</sub> =10V		8		nS
Turn-on Rise Time	t <sub>r</sub>			4		nS
Turn-Off Delay Time	t <sub>d(off)</sub>			50		nS
Turn-Off Fall Time	t <sub>f</sub>			10		nS
Source- Drain Diode Characteristics						
Source-drain current(Body Diode)	I <sub>SD</sub>	T <sub>C</sub> =25℃			5.8	A
Pulsed-Source-drain current(Body Diode)	I <sub>SDM</sub>				17.4	A
Forward on voltage	V <sub>SD</sub>	T <sub>j</sub> =25℃,I <sub>SD</sub> =5.8A,V <sub>GS</sub> =0V		0.9	1.1	V
Reverse Recovery Time	t <sub>rr</sub>	T <sub>j</sub> =25℃,I <sub>F</sub> =3A, di/dt=100A/μs		195		nS
Reverse Recovery Charge	Q <sub>rr</sub>			0.68		uC
Peak reverse recovery current	I <sub>rrm</sub>			7		A

Notes: 1. Repetitive Rating: Pulse width limited by maximum junction temperature

2.  $T_j=25^{\circ}C, V_{DD}=50V, V_G=10V, R_G=25\Omega$

## TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (curves)

Figure1. Safe operating area



Figure2. Source-Drain Diode Forward Voltage

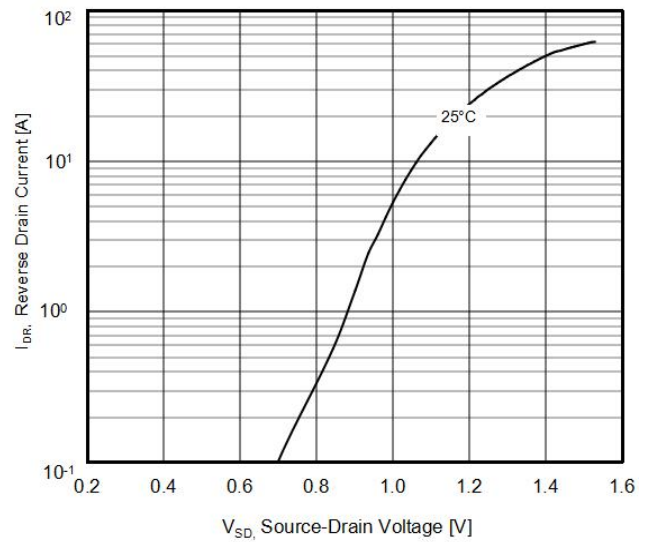


Figure3. Output characteristics

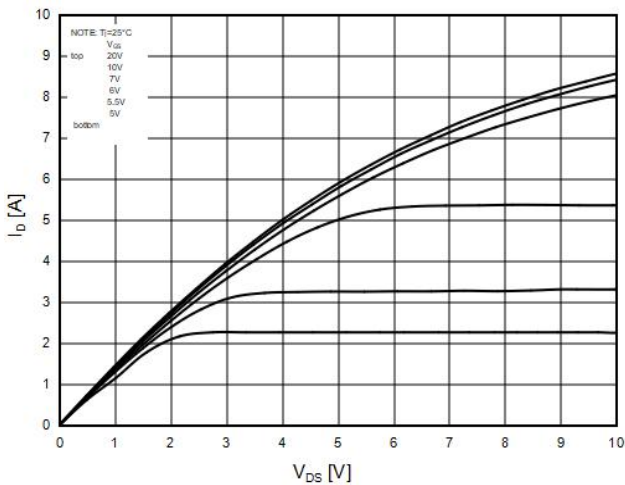


Figure4. Transfer characteristics

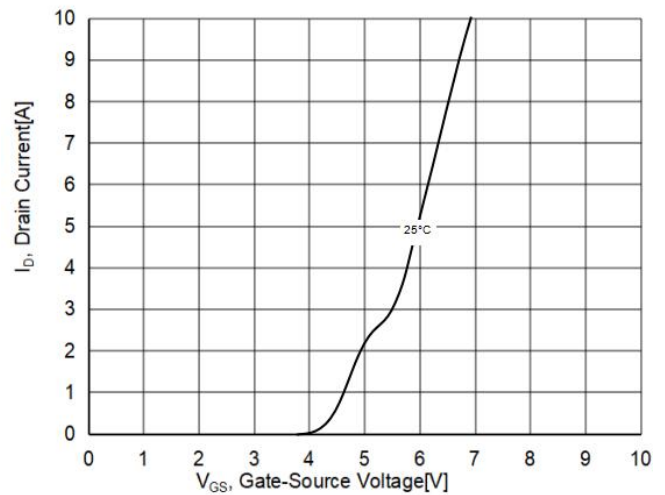


Figure5. Static drain-source on resistance

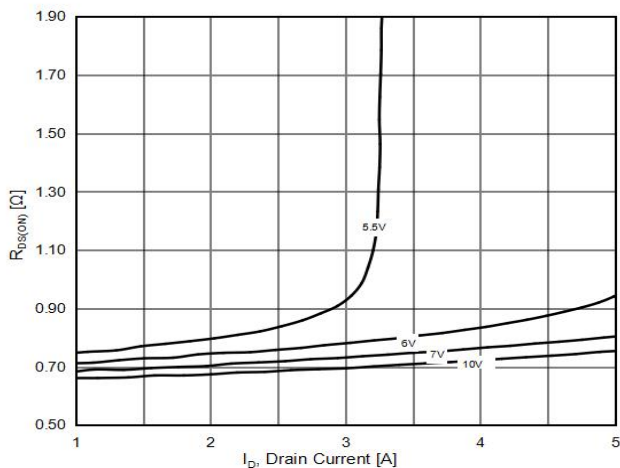
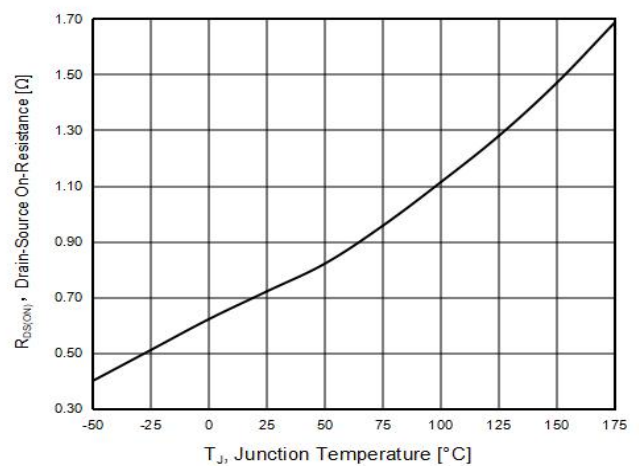
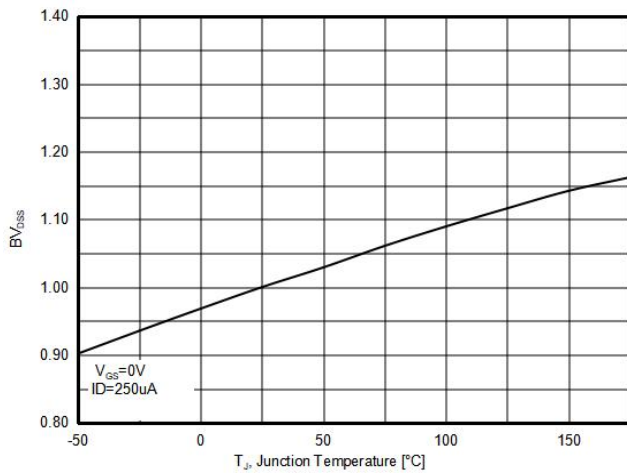


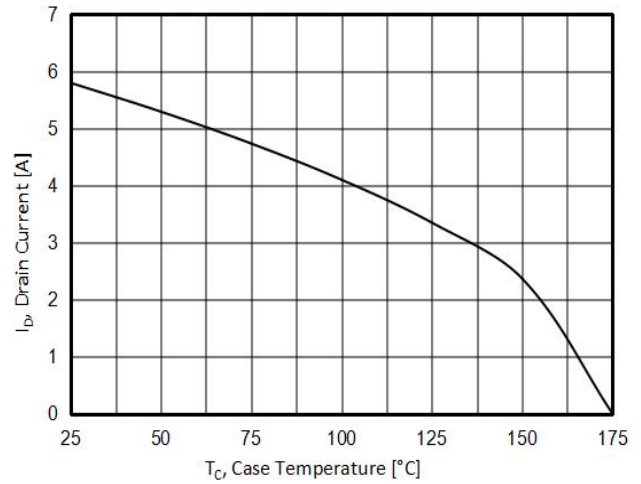
Figure6. RDS(ON) vs Junction Temperature



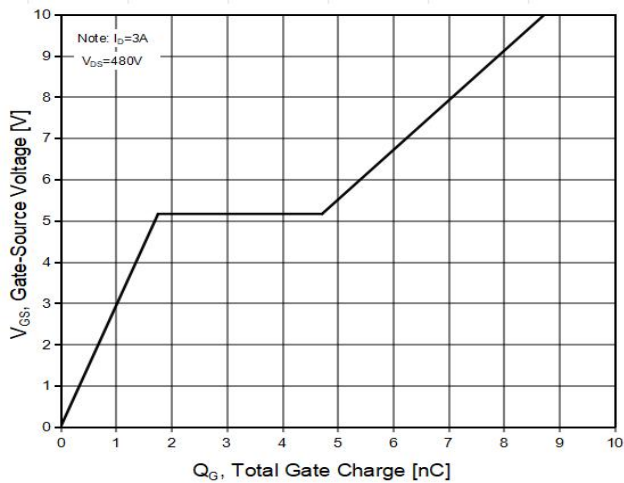
**Figure7.  $BV_{DSS}$  vs Junction Temperature**



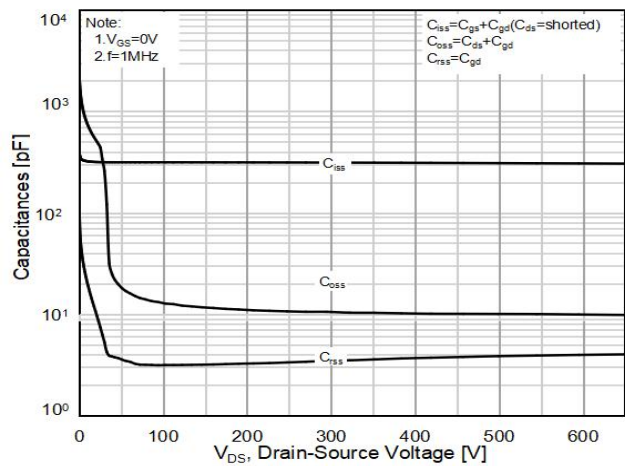
**Figure8. Maximum  $I_D$  vs Junction Temperature**



**Figure9. Gate charge waveforms**



**Figure10. Capacitance**



## Test circuit

### 1) Gate charge test circuit & Waveform



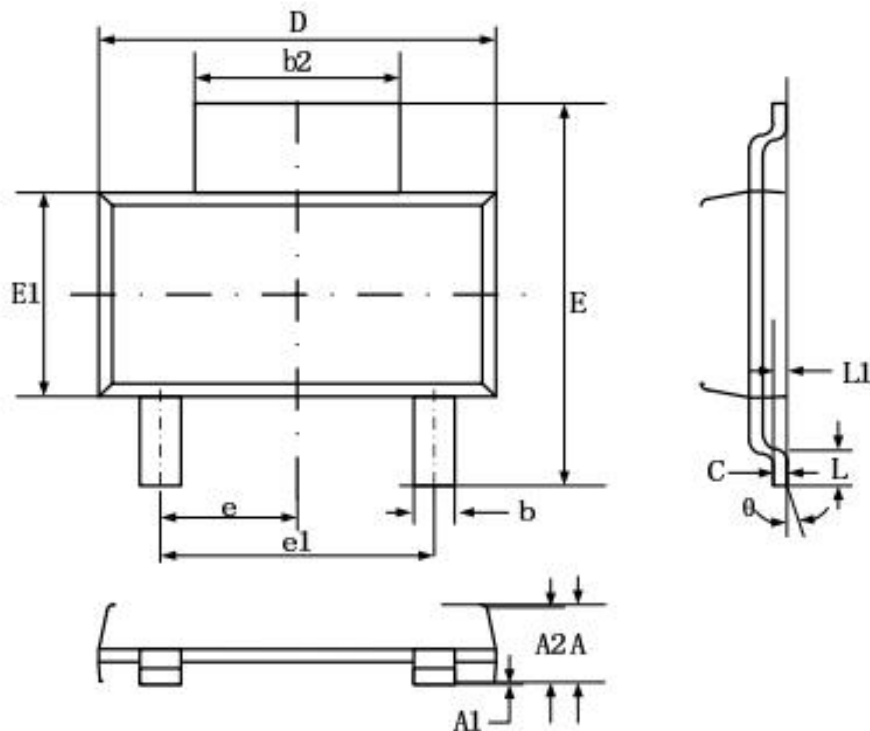
### 2) Switch Time Test Circuit:



### 3) Unclamped Inductive Switching Test Circuit & Waveforms



## SOT-223-2L-B Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	—	1.80	—	0.071
A1	0.02	0.10	0.001	0.004
A2	1.50	1.70	0.059	0.067
b	0.66	0.84	0.026	0.033
b2	2.90	3.10	0.114	0.122
c	0.23	0.35	0.009	0.014
D	6.30	6.70	0.248	0.264
E	6.70	7.30	0.264	0.287
E1	3.30	3.70	0.130	0.146
e	2.30 BSC.		0.091 BSC.	
e1	4.60 BSC.		0.182 BSC.	
L	0.81	—	0.032	—

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